

## Low Voltage Quad 2-Input AND Gate with 5 V Tolerant Inputs

#### **74LCX08**

#### **General Description**

The LCX08 contains four 2-input AND gates. The inputs tolerate voltages up to 5.5 V allowing the interface of 5 V systems to 3 V systems.

The 74LCX08 is fabricated with an advanced CMOS technology to achieve high Speed operation while Maintaining CMOS Low Power Dissipation.

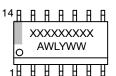
#### **Features**

- 5 V Tolerant Inputs
- 1.65 V 5.5 V V<sub>CC</sub> Specifications Provided
- 5.5 ns  $t_{PD}$  max. ( $V_{CC} = 3.3 \text{ V}$ ), 10  $\mu$ A  $I_{CC}$  max.
- Power Down High Impedance Inputs and Outputs
- $\pm 24$  mA Output Drive ( $V_{CC} = 3.0 \text{ V}$ )
- Implements Proprietary Noise/EMI Reduction Circuitry
- Latch-up Performance Exceeds JEDEC 78 Conditions
- ESD Performance:
  - ♦ Human body model > 2000 V
- Leadless DQFN Package
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

#### MARKING DIAGRAM



SOIC-14 D SUFFIX CASE 751EF





TSSOP-14 DT SUFFIX CASE 948G



XXXXXX = Specific Device Code A = Assembly Location

WL, L = Wafer Lot
YY,Y = Year
WW,W = Work Week
G or = Pb-Free Package

(Note: Microdot may be in either location)



QFN14, 3.0X2.5, 0.5P CASE 510CB



XXXXXX = Specific Device Code Z = Assembly Plant Code

XY = Date Code

KK = Lot Run Traceability Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

#### **CONNECTION DIAGRAMS**

# A<sub>0</sub> 1 14 V<sub>CC</sub> 13 A<sub>2</sub> 12 B<sub>2</sub> 11 O<sub>2</sub> 10 A<sub>3</sub> O<sub>1</sub> 6 9 B<sub>3</sub> GND 7 8 O<sub>3</sub>

Figure 1. Pin Assignments for SOIC, SOP and TSSOP

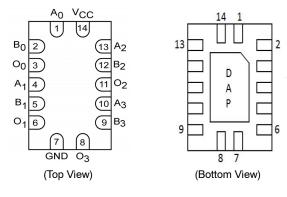


Figure 2. Pad Assignments for DQFN

#### LOGIC SYMBOL

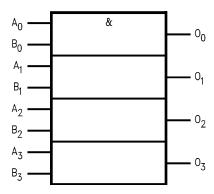


Figure 3. IEEE/IEC

#### **PIN DESCRIPTION**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
O <sub>n</sub>	Outputs
DAP	No Connect

NOTE: DAP (Die Attach Pad)

#### 74LCX08

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
Vo		de (High or Low State) Tri-State Mode own Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>I</sub> < GND	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>O</sub> < GND	-50	mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Ground Pin		±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
$T_L$	Lead Temperature, 1 mm from Case for 10 secs		260	°C
$T_J$	Junction Temperature Under Bias		+150	°C
θJA	Thermal Resistance (Note 1)	SOIC-14 QFN14 TSSOP-14	116 130 150	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 125°C	SOIC-14 QFN14 TSSOP-14	1077 962 833	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V <sub>ESD</sub>	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality

- should not be assumed, damage may occur and reliability may be affected.

  1. I<sub>O</sub> absolute maximum rating must be observed.

  2. Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.

  3. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A. (Machine Model) be discontinued.

#### RECOMMENDED OPERATING CONDITIONS

Symbol	Para	ameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	٧
V <sub>I</sub>	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri–State Mode Power Down Mode ( $V_{CC} = 0 \text{ V}$ )	0 0 0	- - -	V <sub>CC</sub> 5.5 5.5	V
T <sub>A</sub>	Operating Free-Air Temperature		-40	-	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Rate	$\begin{array}{c} V_{CC} = 1.65 \text{ V to } 1.95 \text{ V} \\ V_{CC} = 2.3 \text{ V to } 2.7 \text{ V} \\ V_{IN} \text{ from } 0.8 \text{ V to } 2.0 \text{ V, } V_{CC} = 3.0 \text{ V} \\ V_{CC} = 4.5 \text{ V to } 5.5 \text{ V} \end{array}$	0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

#### 74LCX08

#### DC ELECTRICAL CHARACTERISTICS

				$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		T <sub>A</sub> = -40°C	to +125°C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage		1.65 – 1.95	0.65 x V <sub>CC</sub>	-	0.65 x V <sub>CC</sub>	-	V
			2.3 – 2.7	1.7	-	1.7	-	
			3.0 – 3.6	2.0	-	2.0	-	
			4.5 – 5.5	0.70 x V <sub>CC</sub>	_	0.70 x V <sub>CC</sub>	-	
V <sub>IL</sub>	LOW Level Input Voltage		1.65 – 1.95	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	V
			2.3 – 2.7	-	0.7	-	0.7	
			3.0 – 3.6	-	0.8	-	0.8	
			4.5 – 5.5	-	0.30 x V <sub>CC</sub>	-	0.30 x V <sub>CC</sub>	
V <sub>OH</sub>	High-Level Output Voltage	$\begin{aligned} V_I &= V_{IH} \text{ or } V_{IL} \\ I_{OH} &= -100  \mu\text{A} \\ I_{OH} &= -4 \text{ mA} \\ I_{OH} &= -8 \text{ mA} \\ I_{OH} &= -12 \text{ mA} \\ I_{OH} &= -16 \text{ mA} \\ I_{OH} &= -24 \text{ mA} \\ I_{OH} &= -32 \text{ mA} \end{aligned}$	1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	V <sub>CC</sub> - 0.1 1.29 1.8 2.2 2.4 2.2 3.7		V <sub>CC</sub> - 0.1 1.29 1.8 2.2 2.4 2.2 3.7	11111	<b>V</b>
V <sub>OL</sub>	Low-Level Output Voltage	$\begin{aligned} &V_{I} = V_{IH} \text{ or } V_{IL} \\ &I_{OL} = 100  \mu\text{A} \\ &I_{OL} = 4 \text{ mA} \\ &I_{OL} = 8 \text{ mA} \\ &I_{OL} = 12 \text{ mA} \\ &I_{OL} = 16 \text{ mA} \\ &I_{OL} = 24 \text{ mA} \\ &I_{OL} = 32 \text{ mA} \end{aligned}$	1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	V
I <sub>I</sub>	Input Leakage Current	V <sub>I</sub> = 0 to 5.5 V	1.65 – 5.5	-	±5.0	-	±5.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>I</sub> = 5.5 V or V <sub>O</sub> = 5.5 V	0	-	10	-	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = 5.5 V or GND	1.65 – 5.5	-	10	-	10	μΑ
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V	2.3 – 3.6	-	500	-	500	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### 74LCX08

#### **AC ELECTRICAL CHARACTERISTICS**

				$T_A = -40^{\circ}C$	C to +85°C	$T_A = -40^{\circ}C$	to +125°C					
Symbol	Parameter	Test Condition	V <sub>CC</sub> (V)	Min	Max	Min	Max	Unit				
t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PHL</sub> Propagation Delay, Input to Output	See Figures 4	1.65 –1.95	_	9.8	-	9.8	ns				
		and 5	2.3 – 2.7	1.5	6.6	1.5	6.6					
			2.7	1.5	6.2	1.5	6.2					
									3.0 – 3.6	1.5	5.5	1.5
			4.5 – 5.5	_	4.0	-	4.0					
toshL, toshH	Output to Output Skew		1.65 – 1.95	-	-	-	-	ns				
				2.3 – 2.7	_	-	-	-				
								2.7	_	-	-	-
					3.0 – 3.6	-	1.0	-	1.0			
			4.5 – 5.5	-	-	-	-					

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

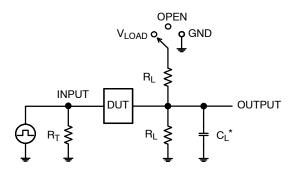
#### **DYNAMIC SWITCHING CHARACTERISTICS**

				T <sub>A</sub> = 25°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Test Conditions	Typical	Unit
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	3.3	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	0.8	V
		2.5	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$	0.6	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	3.3	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	-0.8	V
		2.5	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V	-0.6	

#### CAPACITANCE

Symbol	Parameter	Test Conditions	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = Open, $V_I$ = 0 V or $V_{CC}$	7.0	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3 \text{ V}, V_{I} = 0 \text{ V or } V_{CC}$	8.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC}$ = 3.3 V, $V_I$ = 0 V or $V_{CC}$ , f = 10 MHz	25.0	pF

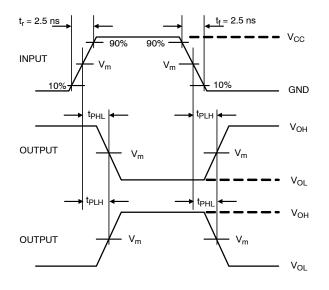
#### AC LOADING AND WAVEFORMS (GENERIC FOR LCX FAMILY)

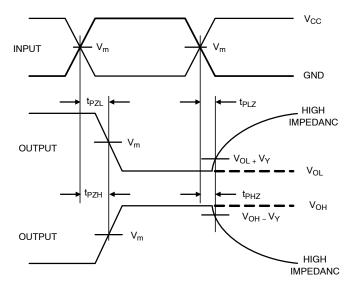


Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	$V_{LOAD}$
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 Mhz,  $t_W$  = 500 ns

Figure 4. Test Circuit





V <sub>CC</sub> , V	$R_L,\Omega$	C <sub>L</sub> , pF	V <sub>LOAD</sub>	V <sub>m</sub> , V	V <sub>Y</sub> , V
1.65 to 1.95	500	30	2 x V <sub>CC</sub>	V <sub>CC</sub> /2	0.15
2.3 to 2.7	500	30	2 x V <sub>CC</sub>	V <sub>CC</sub> /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	2 x V <sub>CC</sub>	V <sub>CC</sub> /2	0.3

Figure 5. Switching Waveforms

#### SCHEMATIC DIAGRAM (Generic for LCX Family)

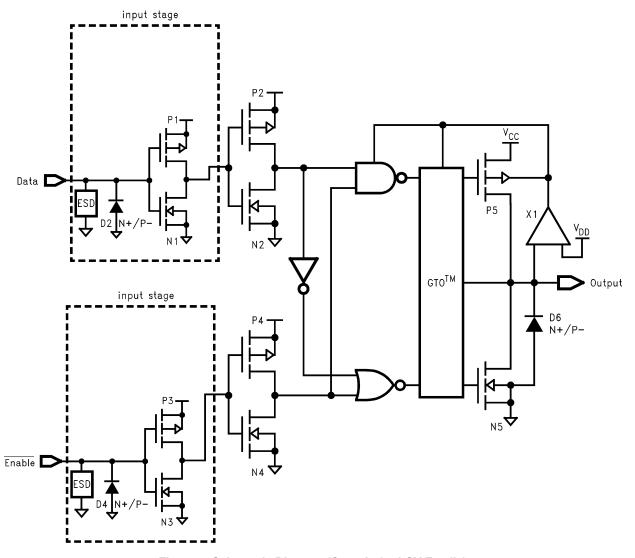


Figure 6. Schematic Diagram (Generic for LCX Family)

#### **ORDERING NFORMATION**

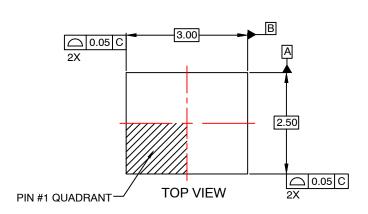
Product Number	Marking	Package	Shipping <sup>†</sup>
74LCX08MTCX	LCX 08	TSSOP-14	2500 Units / Tape and Reel
74LCX08BQX	LCX08	QFN-14	3000 Units / Tape and Reel

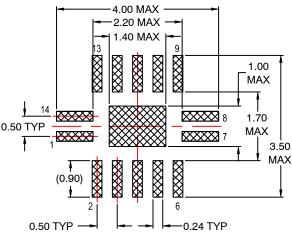
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



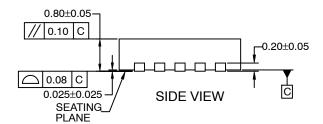
#### QFN14 3.0x2.5, 0.5P CASE 510CB ISSUE O

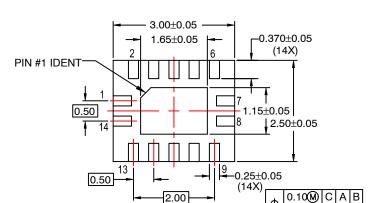
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RECOMMENDED LAND PATTERN





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**BOTTOM VIEW** 

#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

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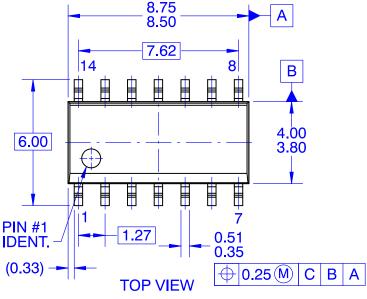
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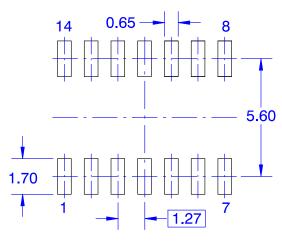
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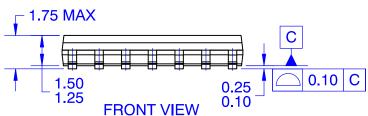
SOIC14 CASE 751EF **ISSUE O** 

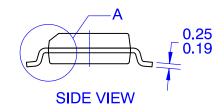
**DATE 30 SEP 2016** 





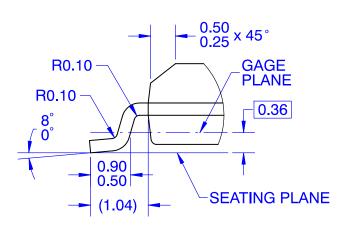
LAND PATTERN RECOMMENDATION





#### **NOTES:**

- A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C
  B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS DO NOT INCLUDE MOLD
- FLASH OR BURRS
- D. LAND PATTERN STANDARD: SOIC127P600X145-14M
- E. CONFORMS TO ASME Y14.5M, 2009



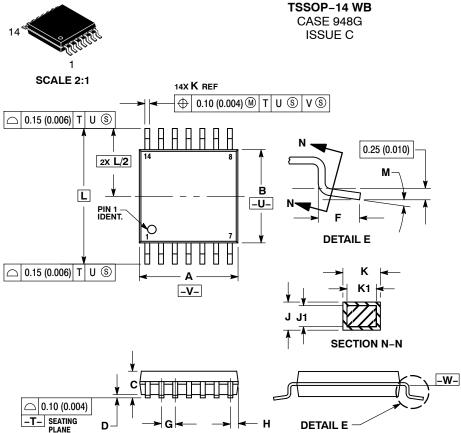
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- NOTES.

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE
- INTERLEAD FLASH OR PROTRUSION.
  INTERLEAD FLASH OR PROTRUSION SHALL
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

  TERMINAL NUMBERS ARE SHOWN FOR DEEEDENIC OMITY.
- REFERENCE ONLY.
  DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
м	o °	8 °	o °	a °

#### **GENERIC MARKING DIAGRAM\***



= Assembly Location

L = Wafer Lot = Year = Work Week W

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

#### **RECOMMENDED SOLDERING FOOTPRINT\***

-	7.06
1	
	-
J	PITCH
14X 0.36	_==+
0.36 - 1.26	DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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